

MITSUBISHI IGBT MODULES  
**CM100DY-24NF**

HIGH POWER SWITCHING USE

**CM100DY-24NF**



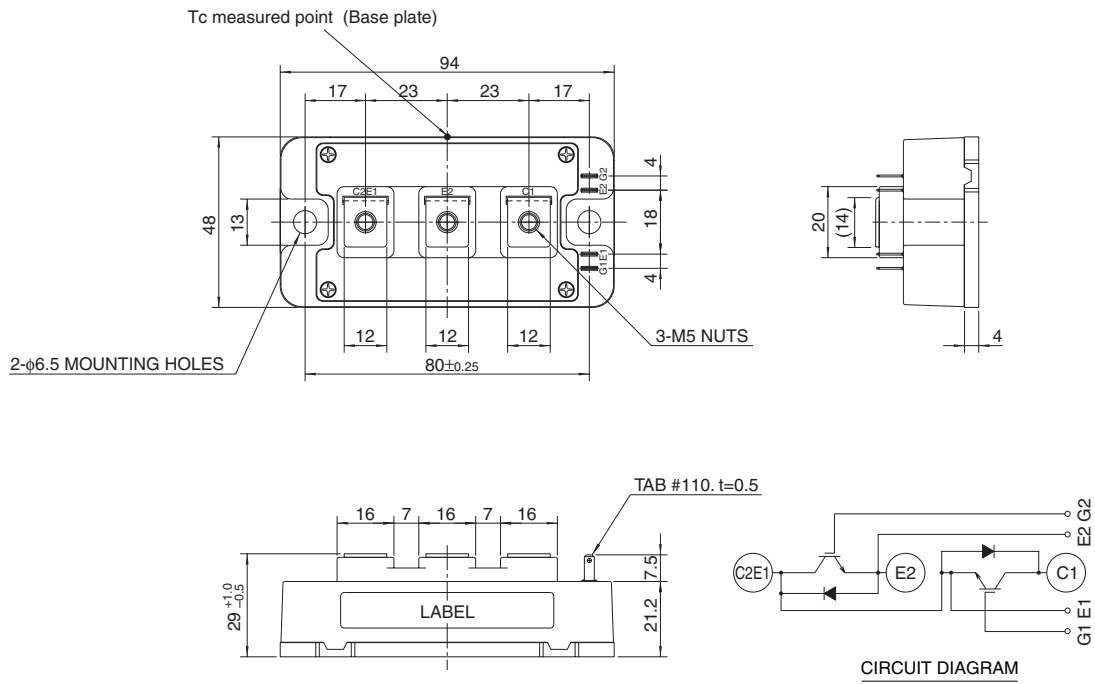
- IC ..... 100A
- VCES ..... 1200V
- Insulated Type
- 2-elements in a pack

**APPLICATION**

General purpose inverters & Servo controls, etc

**OUTLINE DRAWING & CIRCUIT DIAGRAM**

Dimensions in mm



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**MAXIMUM RATINGS** (T<sub>j</sub> = 25°C, unless otherwise specified)

| Symbol                   | Parameter                     | Conditions                                     | Ratings    | Unit             |
|--------------------------|-------------------------------|--|------------|------------------|
| V <sub>CE</sub> S        | Collector-emitter voltage     | G-E Short                                      | 1200       | V                |
| V <sub>GE</sub> S        | Gate-emitter voltage          | C-E Short                                      | ±20        | V                |
| I <sub>C</sub>           | Collector current             | DC, T <sub>c</sub> ' = 113°C <sup>*3</sup>     | 100        | A                |
| I <sub>CM</sub>          |                               | Pulse (Note 2)                                 | 200        | A                |
| I <sub>E</sub> (Note 1)  | Emitter current               |  | 100        | A                |
| I <sub>EM</sub> (Note 1) |                               | Pulse (Note 2)                                 | 200        | A                |
| P <sub>C</sub> (Note 3)  | Maximum collector dissipation | T <sub>c</sub> = 25°C                          | 650        | W                |
| T <sub>j</sub>           | Junction temperature          |  | -40 ~ +150 | °C               |
| T <sub>stg</sub>         | Storage temperature           |  | -40 ~ +125 | °C               |
| V <sub>iso</sub>         | Isolation voltage             | Terminals to base plate, f = 60Hz, AC 1 minute | 2500       | V <sub>rms</sub> |
| —                        | Torque strength               | Main terminals M5 screw                        | 2.5 ~ 3.5  | N • m            |
| —                        |                               | Mounting M6 screw                              | 3.5 ~ 4.5  | N • m            |
| —                        | Weight                        | Typical value                                  | 310        | g                |

**ELECTRICAL CHARACTERISTICS** (T<sub>j</sub> = 25°C, unless otherwise specified)

| Symbol                   | Parameter                            | Test conditions   | Limits                 |      |                    | Unit |   |
|--------------------------|--------------------------------------|---|------------------------|------|--------------------|------|---|
|                          |                                      |   | Min.                   | Typ. | Max.               |      |   |
| I <sub>CES</sub>         | Collector cutoff current             | V <sub>CE</sub> = V <sub>CE</sub> S, V <sub>GE</sub> = 0V   | —                      | —    | 1                  | mA   |   |
| V <sub>GE(th)</sub>      | Gate-emitter threshold voltage       | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 10V  | 6                      | 7    | 8                  | V    |   |
| I <sub>GES</sub>         | Gate leakage current                 | ±V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0V  | —                      | —    | 0.5                | μA   |   |
| V <sub>CE(sat)</sub>     | Collector-emitter saturation voltage | I <sub>C</sub> = 100A, V <sub>GE</sub> = 15V  | T <sub>j</sub> = 25°C  | —    | 1.8                | 2.5  | V |
|                          |                                      |   | T <sub>j</sub> = 125°C | —    | 2.0                | —    |   |
| C <sub>ies</sub>         | Input capacitance                    | V <sub>CE</sub> = 10V<br>V <sub>GE</sub> = 0V   | —                      | —    | 23                 | nF   |   |
| C <sub>oes</sub>         | Output capacitance                   |   | —                      | —    | 2                  | nF   |   |
| C <sub>res</sub>         | Reverse transfer capacitance         |   | —                      | —    | 0.45               | nF   |   |
| Q <sub>G</sub>           | Total gate charge                    | V <sub>CC</sub> = 600V, I <sub>C</sub> = 100A, V <sub>GE</sub> = 15V  | —                      | 675  | —                  | nC   |   |
| t <sub>d(on)</sub>       | Turn-on delay time                   | V <sub>CC</sub> = 600V, I <sub>C</sub> = 100A<br>V <sub>GE</sub> = ±15V<br>R <sub>G</sub> = 3.1Ω, Inductive load<br>I <sub>E</sub> = 100A | —                      | —    | 120                | ns   |   |
| t <sub>r</sub>           | Turn-on rise time                    |   | —                      | —    | 80                 | ns   |   |
| t <sub>d(off)</sub>      | Turn-off delay time                  |   | —                      | —    | 450                | ns   |   |
| t <sub>f</sub>           | Turn-off fall time                   |   | —                      | —    | 350                | ns   |   |
| t <sub>rr</sub> (Note 1) | Reverse recovery time                |   | —                      | —    | 150                | ns   |   |
| Q <sub>rr</sub> (Note 1) | Reverse recovery charge              |   | —                      | 5.0  | —                  | μC   |   |
| V <sub>EC</sub> (Note 1) | Emitter-collector voltage            | I <sub>E</sub> = 100A, V <sub>GE</sub> = 0V   | —                      | —    | 3.2                | V    |   |
| R <sub>th(j-c)Q</sub>    | Thermal resistance <sup>*1</sup>     | IGBT part (1/2 module)  | —                      | —    | 0.19               | K/W  |   |
| R <sub>th(j-c)R</sub>    |                                      | FWDi part (1/2 module)  | —                      | —    | 0.35               | K/W  |   |
| R <sub>th(c-f)</sub>     | Contact thermal resistance           | Case to heat sink, Thermal compound Applied <sup>*2</sup> (1/2 module)  | —                      | 0.07 | —                  | K/W  |   |
| R <sub>th(j-c')Q</sub>   | Thermal resistance                   | Case temperature measured point is just under the chips   | —                      | —    | 0.13 <sup>*3</sup> | K/W  |   |
| R <sub>G</sub>           | External gate resistance             |   | 3.1                    | —    | 31                 | Ω    |   |

\*1 : Case temperature (T<sub>c</sub>) measured point is shown in page OUTLINE DRAWING.

\*2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m • K)].

\*3 : Case temperature (T<sub>c</sub>) measured point is just under the chips.

If you use this value, R<sub>th(f-a)</sub> should be measured just under the chips.

Note 1. I<sub>E</sub>, V<sub>EC</sub>, t<sub>rr</sub> & Q<sub>rr</sub> represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).

2. Pulse width and repetition rate should be such that the device junction temperature (T<sub>j</sub>) does not exceed T<sub>jmax</sub> rating.

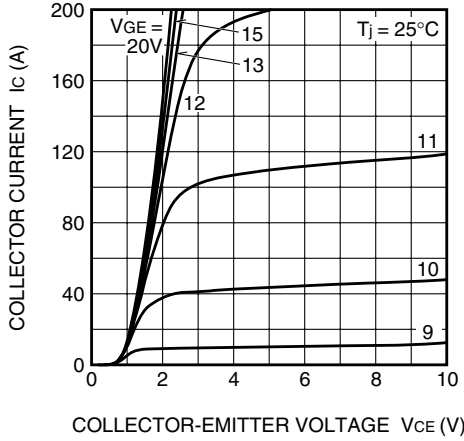
3. Junction temperature (T<sub>j</sub>) should not increase beyond 150°C.

# CM100DY-24NF

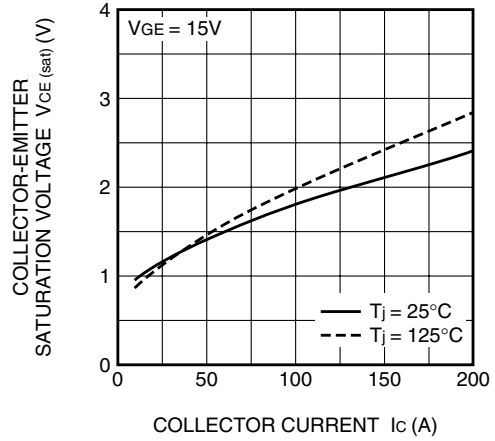
HIGH POWER SWITCHING USE

PERFORMANCE CURVES

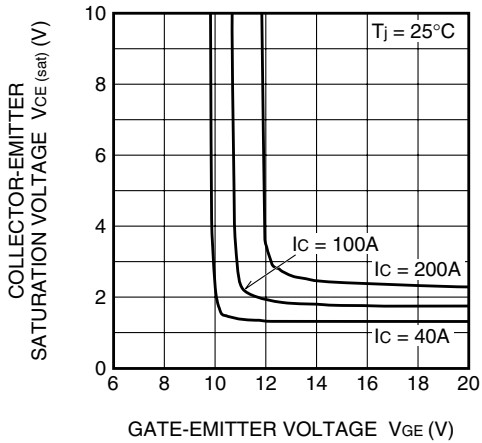
OUTPUT CHARACTERISTICS (TYPICAL)



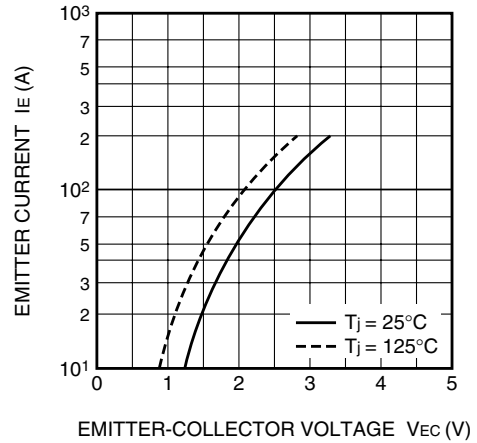
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



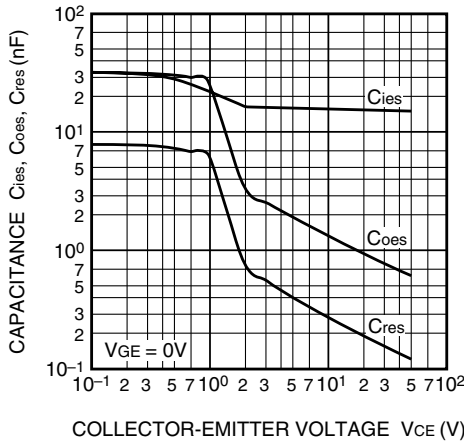
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



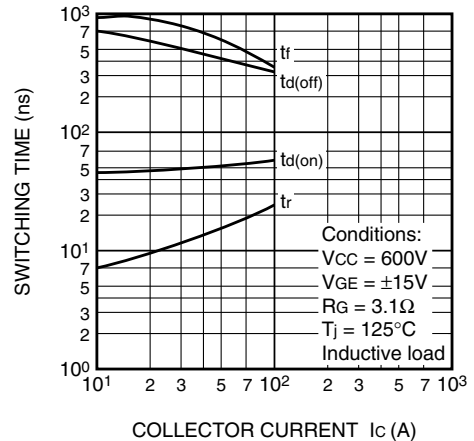
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



CAPACITANCE-VCE CHARACTERISTICS (TYPICAL)



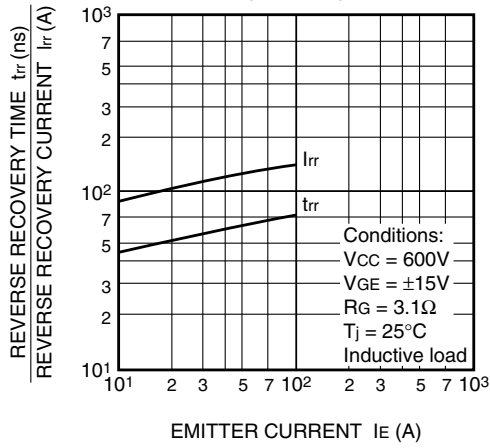
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



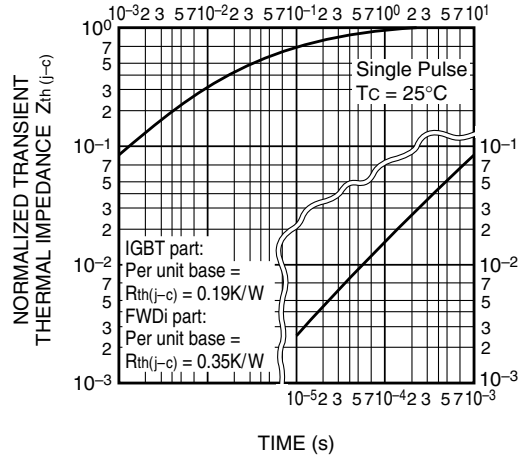
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HIGH POWER SWITCHING USE

REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT part & FWDi part)



GATE CHARGE CHARACTERISTICS (TYPICAL)

